

REF\_SSR\_AC\_DC\_2A

### **About this document**

### **Scope and purpose**

This user guide describes how to use the solid-state-relay (SSR) reference design board: REF\_SSR\_AC\_DC\_2A. It also provides a brief overview of the SSR concept and helpful design tips.

#### Intended audience

This document is intended for engineers evaluating a possibility to use solid-state relays in combination with Infineon devices.

#### **Reference Board/Kit**

Product(s) embedded on a PCB with a focus on specific applications and defined use cases that may include software. PCB and auxiliary circuits are optimized for the requirements of the target application.

REF\_SSR\_AC\_DC\_2A

**Important notice** 



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#### REF\_SSR\_AC\_DC\_2A

**Safety precautions** 



## **Safety precautions**

Note: Please note the following warnings regarding the hazards associated with development systems

### Table 1 Safety precautions

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**Warning:** The evaluation or reference board is connected to the grid input during testing. Hence, high-voltage differential probes must be used when measuring voltage waveforms by oscilloscope. Failure to do so may result in personal injury or death. Darkened display LEDs are not an indication that capacitors have discharged to safe voltage levels.



**Warning:** Remove or disconnect grid input power from the boards before you disconnect or reconnect wires or perform maintenance work. Failure to do so may result in personal injury or death. GUI or display measurements may not be an indication that supply is at safe voltage levels as communication may get interrupted during testing.



**Caution:** The heat sink and device surfaces of the evaluation or reference board may become hot during testing. Hence, necessary precautions are required while handling the board. Failure to comply may cause injury.



**Caution:** Only personnel familiar with the drive, power electronics and associated machinery should plan, install, commission and subsequently service the system. Failure to comply may result in personal injury and/or equipment damage.



**Caution:** The evaluation or reference board contains parts and assemblies sensitive to electrostatic discharge (ESD). Electrostatic control precautions are required when installing, testing, servicing or repairing the assembly. Component damage may result if ESD control procedures are not followed. If you are not familiar with electrostatic control procedures, refer to the applicable ESD protection handbooks and guidelines.



**Caution:** A load and/or boards that are incorrectly applied or installed can lead to component damage or reduction in product lifetime. Wiring or application errors such as undersizing the load or wires, supplying an incorrect or inadequate AC supply, or excessive ambient temperatures may result in system malfunction.



**Caution:** The evaluation or reference board is shipped with packing materials that need to be removed prior to installation. Failure to remove all packing materials that are unnecessary for system installation may result in overheating or abnormal operating conditions.

## REF\_SSR\_AC\_DC\_2A

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#### **Introduction to SSR**



### 1 Introduction to SSR

Solid-state relays are electronic switches capable of turning a circuit on or off using a small control signal, typically a low-voltage DC signal. Traditionally, most relays used on the market today are electromechanical, meaning they consist of mechanical moving parts. Contrary to this, this board has no moving parts and is based on semiconductor technology. This reference board serves as a guide on using and designing such an SSR board.

The SSR reference design (REF\_SSR\_AC\_DC\_2A) is suitable for switching up to 2 A nominal current loads in a 250 VAC or 350 VDC grid supply.

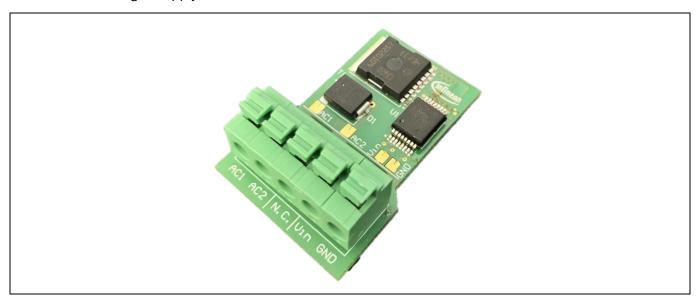


Figure 1 SSR reference board

## 1.1 Block diagram

As shown in Figure 2, back-to-back MOSFETs are used to support the bidirectional current blocking capability. There are two isolated voltage domains, the input of the gate driver and the grid AC or DC supply. For this version of the board, the logic input is 3.3 V, but it can be changed by adjusting the resistor (see Table 2). The gate driver has an integrated transformer that provides the gate driving voltage to the MOSFETs. There is a transient-voltage-suppression (TVS) diode across the FETs to clamp the inductive energy at the switch-off. The overtemperature and overcurrent protection are achieved by using the junction temperature measurement and a shunt resistor respectively.

#### **Introduction to SSR**



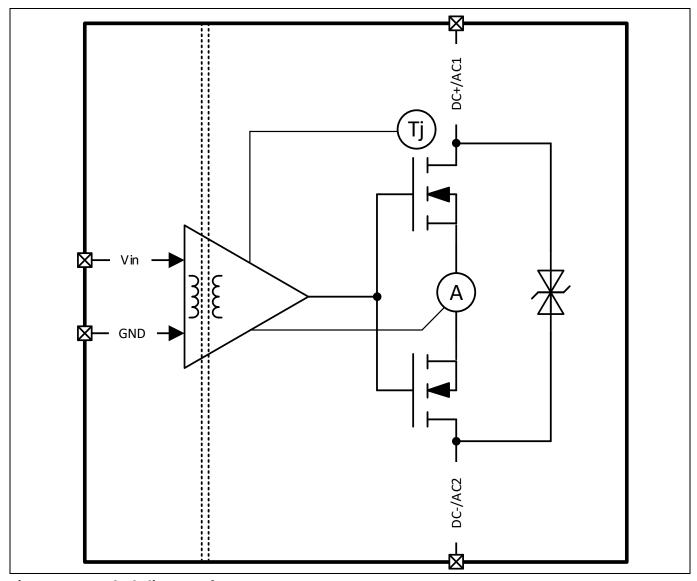


Figure 2 Block diagram of SSR

## 1.2 Key features

The key electrical features of the SSR reference design are as follows:

- Back-to-back (B2B) CoolMOS™ configuration for bidirectional current blocking capability
- Adjustable input supply voltage
- CoolMOS™ S7T (IPT60T022S7) [1] power FETs with embedded temperature sensor for measuring the junction temperature (Tj) and enabling overtemperature protection
- Shunt resistor-based channel current measurement
- Solid-State Isolator (ISSI30R12H) [2] with integrated provisions for overcurrent (OCD) and overtemperature protection (OVT)
- External clamping elements for overvoltage protection (OVP)

## REF\_SSR\_AC\_DC\_2A

**Introduction to SSR** 



#### **Board parameters and technical data** 1.3

Table 2 **Operating parameters** 

Parameter	Min.	Тур.	Max.	Unit
Maximum switching voltage	-	250	-	V AC
	_	350	_	V DC
Nominal switching current	_	2	_	А
Input supply voltage [2]	2.5	3.3	3.5	V DC
Overcurrent limit	27	29	31	Α
Overtemperature limit	145	150	155	°C
Ambient operating temperature (Ta)	_	25	40	°C
Pollution degree	II			
Overvoltage category	II			
Maximum altitude	2000 m			

Note:

For more information on the input supply voltage, see the iSSI30R12H datasheet (Chapter 7.1 Adaptation of the supply voltage).

System and functional description



## 2 System and functional description

## 2.1 Getting started

To use a relay, a simple connection diagram can be observed (Figure 3).

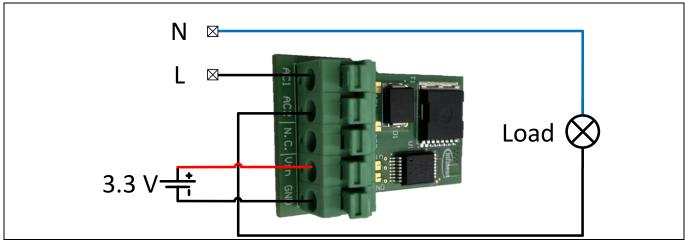


Figure 3 SSR connection diagram

In addition to using a terminal connector block, respective pads on the board can also be used (Figure 4). These can be used by breaking off the connector block and directly soldering the wires or leads to the pads of the device. This way, a reduced footprint of the device can be achieved. However, for evaluation purposes and ease of use, using the connector block is recommended.

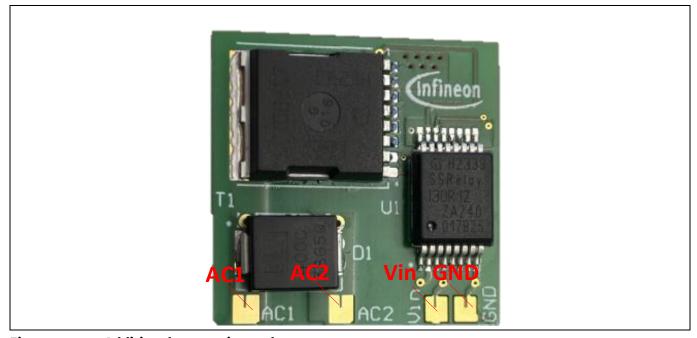


Figure 4 Additional connection pads

#### REF\_SSR\_AC\_DC\_2A

System and functional description



### 2.2 Operation

The device is simple to operate and can be used as any other switch/relay on the market. When the logic supply voltage is present, the SSR is "ON" (conducting). By disabling the logic supply input, the SSR turns "OFF" (not conducting).

Additional features compared to a standard relay are overcurrent, overtemperature, and overvoltage protection.

### 2.3 Overcurrent protection

The overcurrent protection is achieved with a combination of a shunt resistor used for current measurement and an overcurrent comparator shutdown threshold implemented in the gate driver. The typical comparator shutdown threshold is internally set in the gate driver at a value of 200 mV. By using a 7 m $\Omega$  shunt, a typical shutdown current of 29 A can be expected. This overcurrent value is selected to support the AC-15 system tests as per IEC 60947-5-1 guidelines under appropriate operating conditions.

The triggering of the overcurrent protection leads to a latched turn-off of the power switch. To return to normal operation, applying 0 V to the supply input is required.

### 2.4 Overtemperature protection

The overtemperature is achieved by using the combination of CoolMOS<sup>TM</sup> S7T and the iSSI30R12H gate driver. The gate driver can source the bias current of 50  $\mu$ A needed for the readout of the integrated temperature sensor of the S7T MOSFET. At the same time, it detects a typical threshold voltage of 1.095 V, which correlates to a junction temperature of  $\approx$ 150°C. For more details on how the integrated temperature sensor of the S7T works, see the product application note [4].

Once again, the triggering of the overtemperature protection leads to a latched turn-off of the power switch. To return to normal operation, applying 0 V to the logic supply input is required.

## 2.5 Overvoltage protection

As an additional protection element, a bidirectional TVS diode is added. In such a compact layout, an additional RC snubber is also needed to prevent the return-on of the device caused by the high-frequency oscillations happening due to TVS diode coupling with the gate output of the driver. For larger boards, placing the TVS further away from the gate driver and MOSFET helps in this perspective by filtering out the high-frequency noise caused by the TVS.

## 2.5.1 TVS diode dimensioning

The absolute maximum drain-source voltage of the S7T MOSFET is 600 V. The protection elements need to be selected so that the clamping voltage is below this value under all stress patterns. On the other hand, the TVS clamping voltage needs to be above the peak value of the maximum rated supply voltage. The needed clamping range for the TVS diode can be seen in Figure 5. The diode must be selected in a way that the diode breakdown voltage ( $V_{BR}$ ) is larger than the peak value of the supply voltage ( $V_{e(peak)}$ ). Simultaneously, the maximum clamping voltage ( $V_{C}$ ) needs to be lower than the transistor breakdown voltage ( $V_{C}$ ).

## REF\_SSR\_AC\_DC\_2A

System and functional description



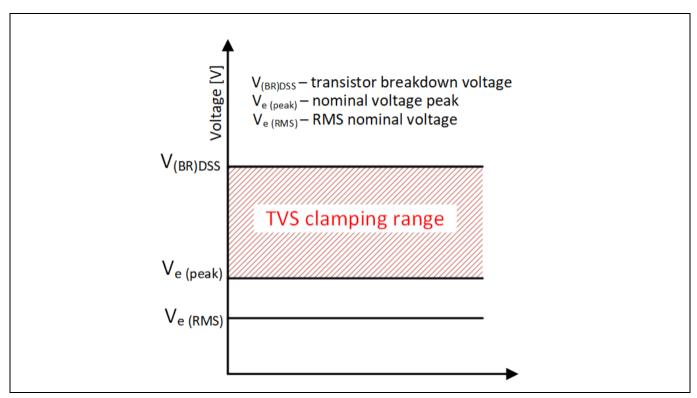


Figure 5 TVS diode clamping range

System design



## 3 System design

## 3.1 Schematics

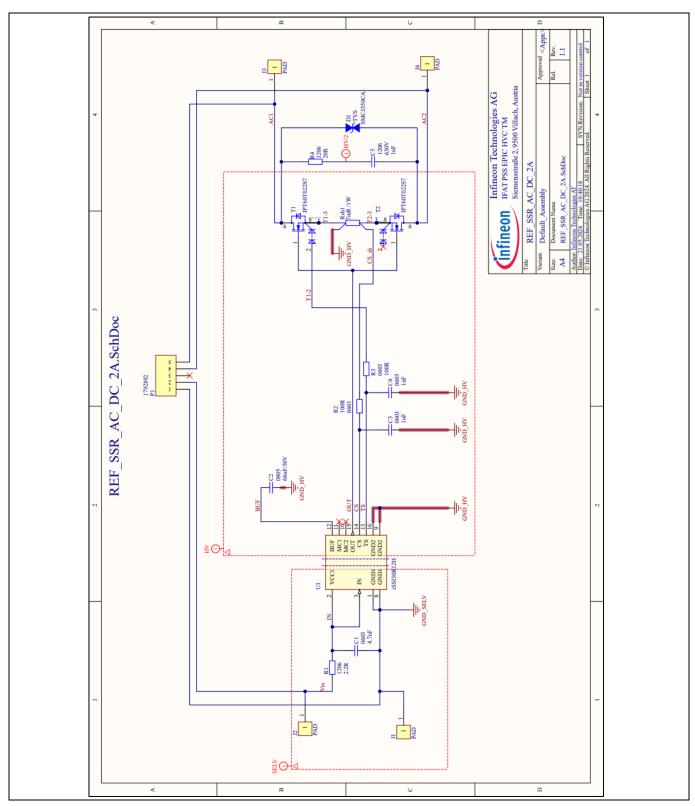


Figure 6 Schematic of REF\_SSR\_AC\_DC\_2A

System design



## 3.2 Layout

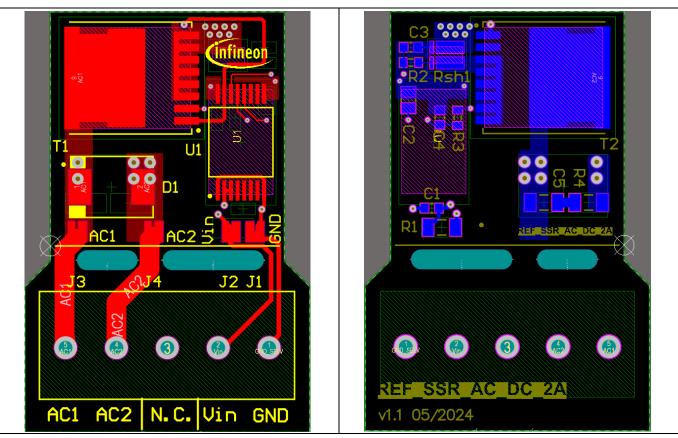


Figure 7 Top (left) and bottom (right) layers of REF\_SSR\_AC\_DC\_2A

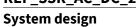
### 3.3 Bill of materials

The complete bill of materials is available on the download section of the Infineon website. Log in to download this information.

Table 3 BOM of REF\_SSR\_AC\_DC\_2A

Quantity	Ref designator	Description	Manufacturer	Manufacturer P/N	Populated
1	C1	CAP SMD CER 4.7 nF 50V X7R 0603	Multicorp PRO	MCSH18B472K500CT	Yes
1	C2	CAP SMD CER 68 nF 50V X7R 0805	Kemet	C0805C683J5RACTU	Yes
2	C3, C4	CAP SMD CER 1000 pF 50V X7R 0603	Yageo	CC0402KRX7R9BB102	Yes
1	C5	CAP SMD CER 1000 pF, 630 V, 50 V C0G, 1206	Murata	GRM31B5C2J102JW01L	Yes
1	D1	TVD DIODE SMC	LittleFuse	SMCJ350CA	Yes
1	P1	Connector block	Phoenix	1792892	Yes
1	R1	RES SMD 2.2 Ω 1206	Vishay	CRCW12062R20FKEA	Yes







Quantity	Ref designator	Description	Manufacturer	Manufacturer P/N	Populated
2	R2, R3	RES SMD 100 Ω 0603	Vishay	CRCW0603100RJNEAIF	Yes
1	R4	RES SMD 20 Ω 1206	Yageo	RC1206JR-0720RL	Yes
1	Rsh1	RES SHUNT 7 mΩ	SUSUMU	KRL3216T4A-M-R007-F-T1	Yes
2	T1, T2	MOSFET N-CH 600 V PG-HSOF-8	Infineon	IPT60T022S7	Yes
1	U1	ISOLATED GATE DRIVER PG-DSO-16- 28	Infineon	ISSI30R12H	Yes

## 3.4 Connector details

Table 4 Connectors

Pin	Label	Function
1	GND	Logic supply pin reference
2	Vin	Logic supply pin
3	N.C.	Not connect
4	AC2	Power output pin (AC or DC-) <sup>1</sup>
5	AC1	Power input pin (AC or DC+) <sup>1</sup>

 $<sup>^{\</sup>rm 1}\,{\rm Pins}\,{\rm AC1}$  and AC2 interchangable for AC operation.

#### REF\_SSR\_AC\_DC\_2A

**System performance** 



## 4 System performance

In the following sections, certain aspects of the system's performance are evaluated.

- The steady-state behavior and the I<sup>2</sup>t curve of the device is shown.
- Some of the cases of overcurrent and overtemperature protection behaviors are shown.

## 4.1 Steady-state behavior

Although the SSR demo board is shipped with a 22 m $\Omega$  CoolMOS<sup>TM</sup> S7T (IPT60T022S7), certain steady-state evaluations have been performed for a 40 m $\Omega$  device (IPT60T040S7) as well. Using an IR camera and the temperature sensor, the package temperature after reaching steady-state conditions at certain loads has been evaluated. The settling time is in the range of 1000 seconds, i.e., 16.7 minutes.

In Figure 8, the settling temperature for an SSR using the 22 m $\Omega$  can be observed. A constant current pulse of 5 A is applied. After the specified time, the temperature settled at 111°C. Depending on the allowed device temperature in the application, different nominal currents can be selected.

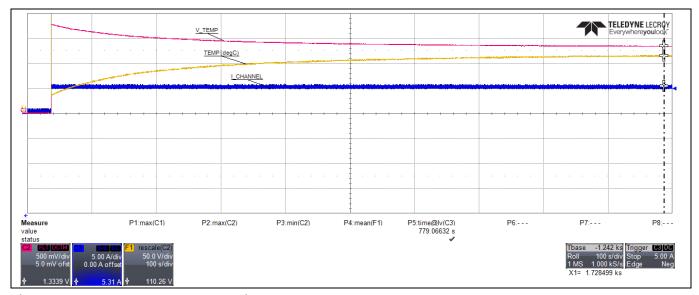


Figure 8 IPT60T022S7 5 A settling temperature

In Table 5, different settling temperatures for different currents can be seen.

Table 5 Settling temperatures at different currents

DC [A]	SSR with 2xIPT60T022S7 settling temp [°C]	SSR with 2xIPT60T040S7 settling temp [°C]
2	41	51
3	53	79
5	111	shutdown after 159 s (OVT)

Apart from the steady-state behavior, transient shutdown behavior can be observed. Considering the SSR consists of two major protection mechanisms, overcurrent and overtemperature shutdown, an  $I^2$ t tripping curve can be extracted. This curve can be seen in Figure 9 for both the 22 m $\Omega$  and 40 m $\Omega$  SSRs. The yellow hard limit is the overcurrent shutdown that is based on the shunt, while the red and blue curves are the respective overtemperature shutdown limits. These of course depend on the ambient temperature of the device, which is in this case 25°C. These curves serve as orientation references, being influenced by various design and

### REF\_SSR\_AC\_DC\_2A

# **Infineon**

**System performance** 

manufacturing factors such as soldering joints and cooling areas. It is important to note that they may not be identical for every device.

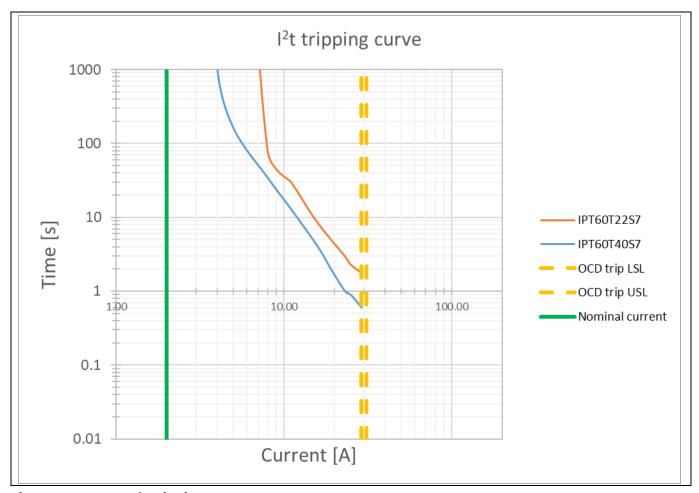


Figure 9 SSR I<sup>2</sup>t tripping curve

## 4.2 Overcurrent protection

The implementation of the overcurrent protection was discussed in Section 2.3. In this chapter, the performance of the protection is evaluated. The worst-case condition for an overcurrent protection would be a short-circuit event. Depending on the type of short-circuit event, different current slopes (di/dt) can be expected. To test this, a capacitive load of a high-voltage DC power supply is used. By increasing the voltage level, the short-circuit current slope is higher.

One of these examples can be seen in Figure 10. This is an overcurrent protection scenario with a short-circuit current slope of 41 A/ $\mu$ s. The respective signals are marked on the oscilloscope screenshot. Even with such a steep current slope, the SSR is quick to respond. This can be observed in the gate signal. Counting from the moment of detecting a fault (gate signal falling edge), until the current starts dropping, takes only 140 ns. The device was tested up to 60 A/ $\mu$ s slew rate with a DC voltage of 350 V.

### REF\_SSR\_AC\_DC\_2A

## System performance



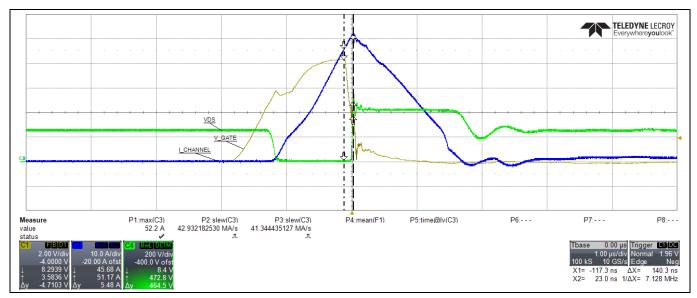


Figure 10 Short-circuit event

With varying slew rates, the maximum trip current varies. As mentioned in the operating conditions, the threshold switch-off current is  $\approx 30$  A. In Figure 11, a relationship between the current slew rate (di/dt) in an overcurrent event and the maximum tripping current can be seen.

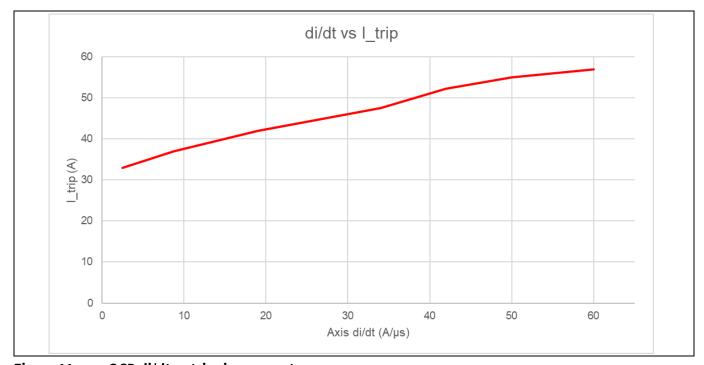


Figure 11 OCD di/dt vs tripping current

## 4.3 Overtemperature protection

Similarly to the overcurrent protection, overtemperature protection was verified using constant DC current. In Figure 12, an overtemperature shutdown event is observed. The temperature diode voltage (V\_TEMP) is dropping (the diode has a negative temperature coefficient) until the set shutdown level. After this, the SSR shuts-off.

### REF\_SSR\_AC\_DC\_2A

## System performance



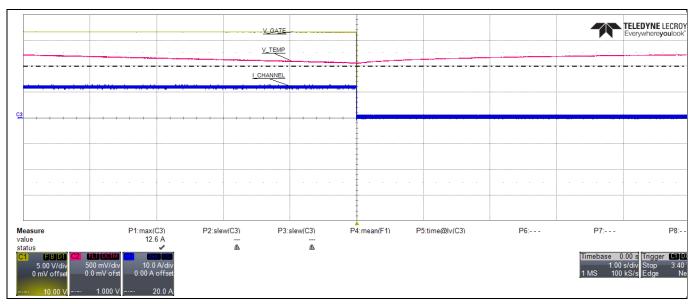


Figure 12 Overtemperature protection event

The same event but zoomed-into can be seen in Figure 13. The device stays latched off until a restart happens by applying 0 V at the input.

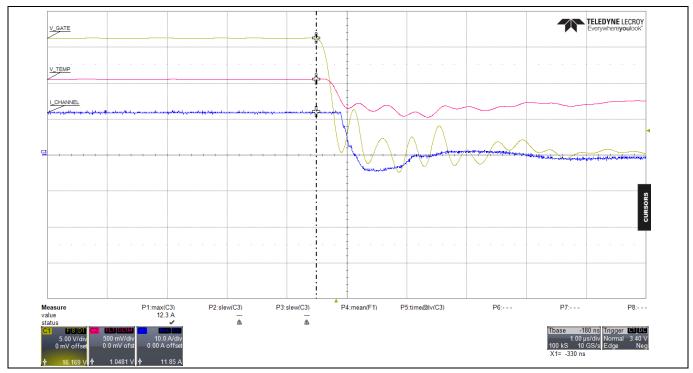


Figure 13 Overtemperature protection event – zoomed in

### REF\_SSR\_AC\_DC\_2A



References

### References

- [1] Infineon Technologies AG.: IPT60T022S7 datasheet Available online
- [2] Infineon Technologies AG.: iSSI20R0xH, iSSI20R11H, and iSSI30R1xH datasheet Available online
- [3] Infineon Technologies AG.: UG-2023-17, Eval-iSSI30R12H user guide. Available online
- [4] Infineon Technologies AG.: AN\_2308\_PL52\_2310\_112138 600 V CoolMOS™ S7 with temperature sense. application note Available online

# Solid-state-relay reference design user guide REF\_SSR\_AC\_DC\_2A



Glossary

## Glossary

#### SSR

solid-state-relay

#### **MOSFET**

metal oxide semiconductor field-effect transistor

#### S7T

Infineon CoolMOS™ S7 with embedded temperature sensor

#### **Δ***C*

alternating current

#### DC

direct current

#### OCD

overcurrent detection

#### OVT

overtemperature

#### OVP

overvoltage protection

#### **TVS**

transient-voltage-suppression

### LSL

Lower specification limit

#### USL

Upper specification limit

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REF\_SSR\_AC\_DC\_2A

**Revision history** 



## **Revision history**

Document revision	Date	Description of changes
V 1.0	2024-06-12	Initial revision

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Edition 2024-06-12 Published by

Infineon Technologies AG 81726 Munich, Germany

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Document reference UG084603

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